



SGM2041

250mA, Ultra-Low Noise, Small Package, Low Dropout, RF Linear Regulator

GENERAL DESCRIPTION

The SGM2041 is an ultra-low noise linear regulator capable of supplying 250mA output current. Designed to meet the requirements of RF and analog circuits, the SGM2041 device provides ultra-low noise, high PSRR, low quiescent current and very good load/line transient responses. The device is designed to work with a 1 μ F input and a 1 μ F output ceramic capacitors.

The SGM2041 is available in a Green WLCSP-0.67 \times 0.67-4B package. It operates over an operating temperature range of -40 $^{\circ}$ C to +125 $^{\circ}$ C.

APPLICATIONS

Battery-Powered Equipment
Wireless LAN Devices
Smart-phones and Tablets
Cameras and Camcorders

FEATURES

- Operating Input Voltage Range: 1.8V to 5.5V
- Fixed Output Voltage Range: 1.2V to 4.2V
- Output Short to GND Protection
- Output Current Limit: 500mA (TYP)
- Over-Temperature Protection: +165 $^{\circ}$ C
- Fast Load and Line Transient Responses
- Ultra-Low Quiescent Current: 13.5 μ A (TYP)
- Shutdown Current: 0.1 μ A (TYP)
- Stable with 1 μ F Small Case Size Ceramic Capacitors
- -40 $^{\circ}$ C to +125 $^{\circ}$ C Operating Temperature Range
- Available in a Green WLCSP-0.67 \times 0.67-4B package

TYPICAL APPLICATION

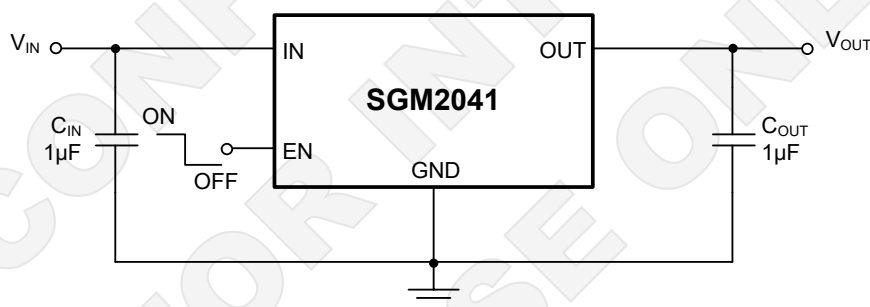


Figure 1. Typical Application Circuit

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2041-1.2	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-1.2XG/TR	Y7	Tape and Reel, 3000
SGM2041-1.5	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-1.5XG/TR	Y8	Tape and Reel, 3000
SGM2041-1.8	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-1.8XG/TR	Y9	Tape and Reel, 3000
SGM2041-2.5	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-2.5XG/TR	YA	Tape and Reel, 3000
SGM2041-2.8	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-2.8XG/TR	I8	Tape and Reel, 3000
SGM2041-3.0	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-3.0XG/TR	YB	Tape and Reel, 3000
SGM2041-3.3	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-3.3XG/TR	YC	Tape and Reel, 3000
SGM2041-3.6	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-3.6XG/TR	YD	Tape and Reel, 3000
SGM2041-4.2	WLCSP-0.67 × 0.67-4B	-40°C to +125°C	SGM2041-4.2XG/TR	YE	Tape and Reel, 3000

MARKING INFORMATION

YY

Serial Number

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

IN to GND	-0.3V to 6V
EN to GND	-0.3V to 6V
OUT to GND	-0.3V to (V _{IN} + 0.3V)
Package Thermal Resistance	
WLCSP-0.67 × 0.67-4B, θ _{JA}	290°C/W
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	8000V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Input Voltage Range	1.8V to 5.5V
Operating Junction Temperature Range	-40°C to +125°C
Input Capacitance, C _{IN}	0.47µF (MIN)
Output Capacitance, C _{OUT}	0.47µF to 10µF

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

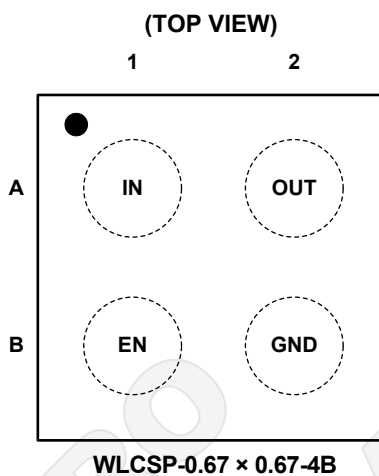
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATION



PIN DESCRIPTION

PIN	NAME	FUNCTION
A1	IN	Input Voltage Supply Pin.
A2	OUT	Regulated Output Voltage. It is recommended to use output capacitor with effective capacitance in the range of 1 μ F to 10 μ F.
B1	EN	Chip Enable. Applying $V_{EN} \leq 0.4V$ disables the regulator; pulling $V_{EN} \geq 1.5V$ enables the LDO.
B2	GND	Common Ground Connection.

ELECTRICAL CHARACTERISTICS

(V_{IN} = V_{OUT(NOM)} + 1.0V, I_{OUT} = 0.1mA, V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1μF, typical values are at T_J = +25°C, unless otherwise noted.)

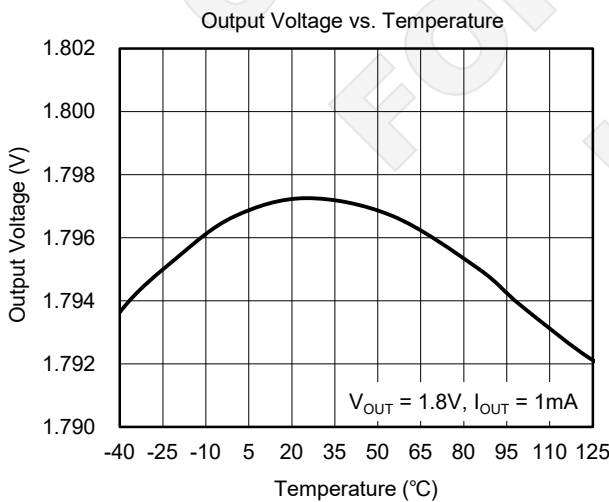
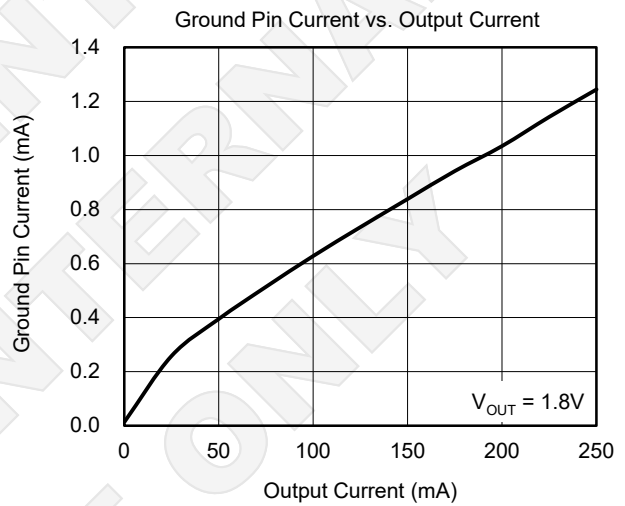
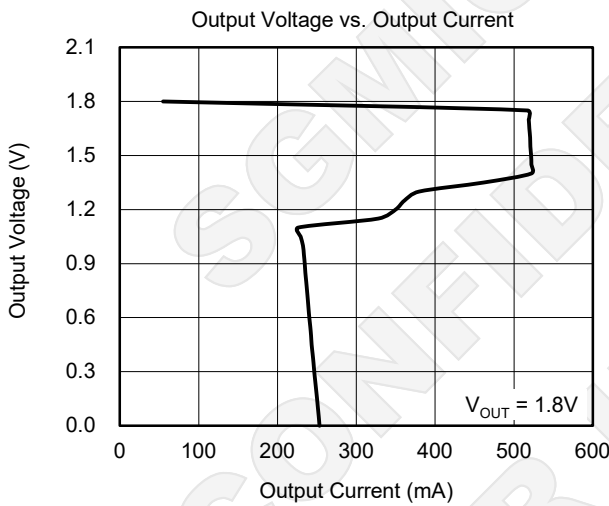
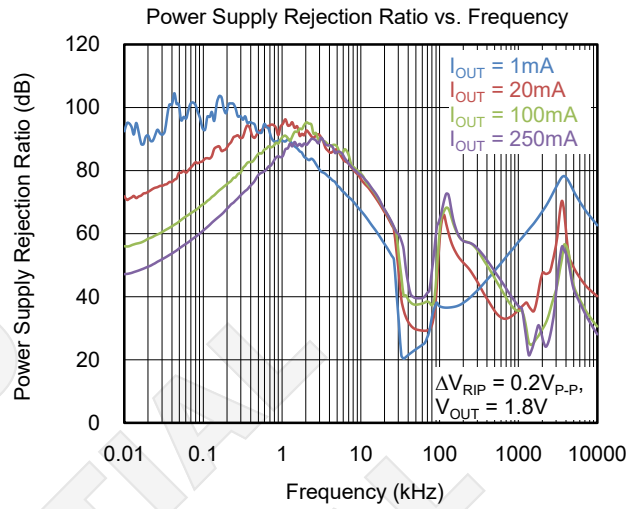
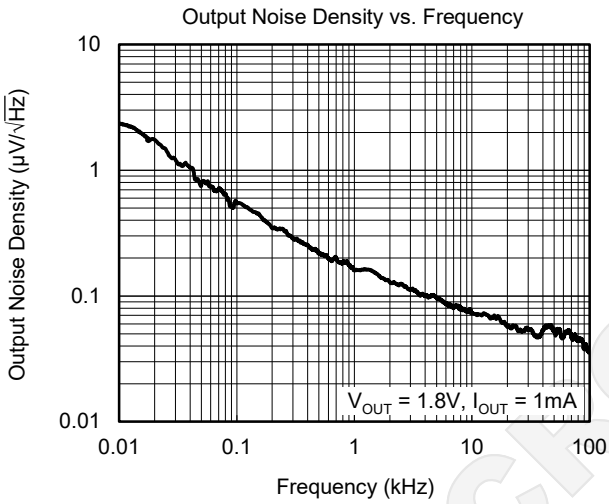
PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
Operating Input Voltage Range	V _{IN}		+25°C	1.8		5.5	V
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \times V_{OUT}}$	V _{IN} = (V _{OUT(NOM)} + 1.0V) to 5.5V	V _{OUT(NOM)} ≤ 3.3V	+25°C	0.01		%V
			V _{OUT(NOM)} = 4.2V	+25°C	0.04		
Load Regulation	ΔV _{OUT}	I _{OUT} = 0.1mA to 250mA	V _{OUT(NOM)} ≤ 1.8V	+25°C	3		mV
			V _{OUT(NOM)} > 1.8V	+25°C	7		
Dropout Voltage ⁽¹⁾	V _{DROP}	I _{OUT} = 250mA, V _{OUT} = 2.8V	+25°C		88		mV
Output Current Limit ⁽²⁾	I _{LIM}		+25°C		500		mA
Short Circuit Current	I _{SC}	V _{OUT} = 0V	+25°C		220		mA
Quiescent Current	I _Q	No load	+25°C		13.5		μA
Shutdown Current	I _{SHDN}	V _{EN} = 0V, V _{IN} = 5.5V	+25°C		0.1		μA
EN Pin Threshold Voltage	V _{IH}	EN input voltage high	+25°C	1.5			V
	V _{IL}	EN input voltage low	+25°C			0.4	
EN Pull-Down Current	I _{EN}	V _{EN} = 5.5V	+25°C		0.2		μA
Turn-On Time	t _{ON}	From assertion of V _{EN} to V _{OUT} = 90% V _{OUT(NOM)}	+25°C		120		μs
Power Supply Rejection Ratio	PSRR	I _{OUT} = 20mA	f = 100Hz	+25°C	84		dB
			f = 1kHz	+25°C	94		
			f = 10kHz	+25°C	73		
			f = 100kHz	+25°C	33		
Output Voltage Noise	e _n	f = 10Hz to 100kHz, V _{OUT} = 2.8V	I _{OUT} = 1mA	+25°C	26		μV _{RMS}
			I _{OUT} = 250mA	+25°C	20		
Output Discharge Resistance	R _{DISCH}	V _{EN} ≤ 0.4V, V _{IN} = 5.0V	+25°C		220		Ω
Thermal Shutdown Temperature	T _{SHDN}				165		°C
Thermal Shutdown Hysteresis	ΔT _{SHDN}				20		°C

NOTES:

- Dropout voltage is characterized when V_{OUT} falls 5% below V_{OUT(NOM)}.
- Output current limit is characterized when V_{OUT} falls 200mV below V_{OUT(NOM)}.

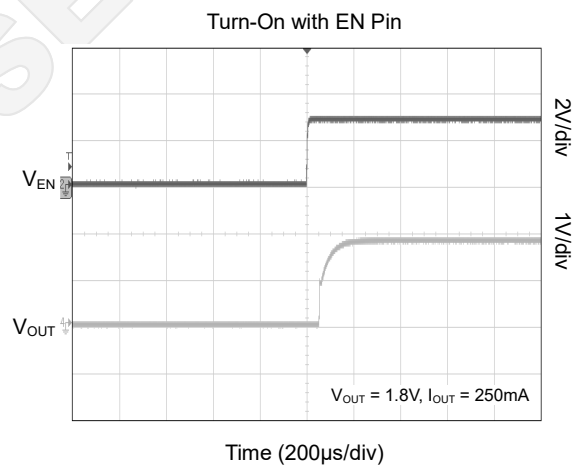
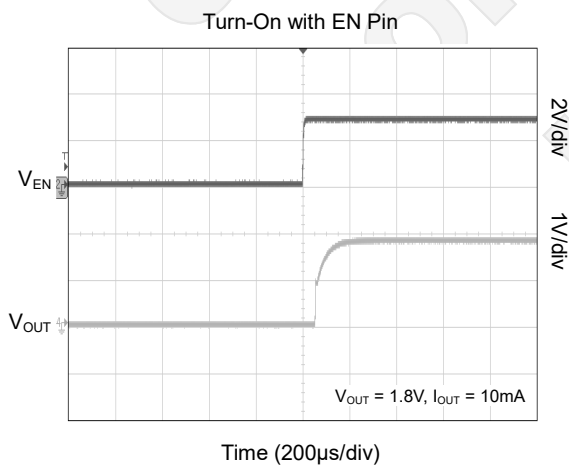
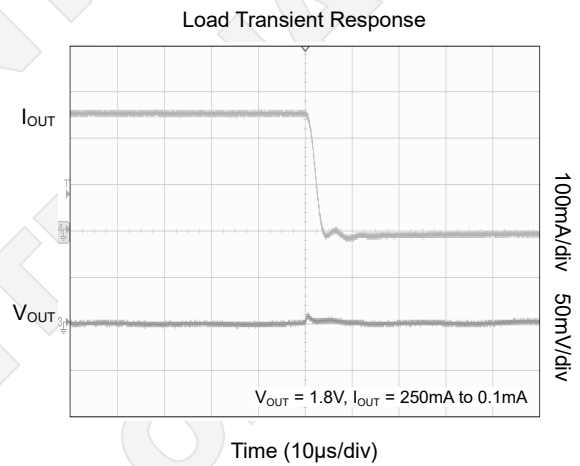
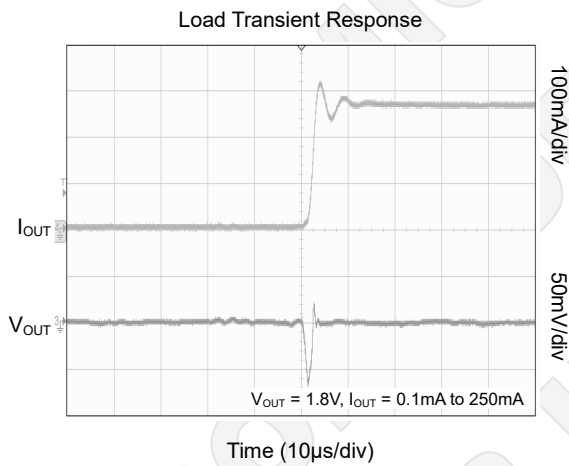
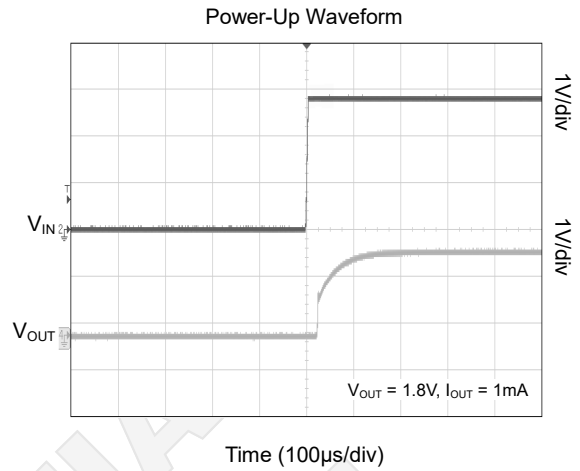
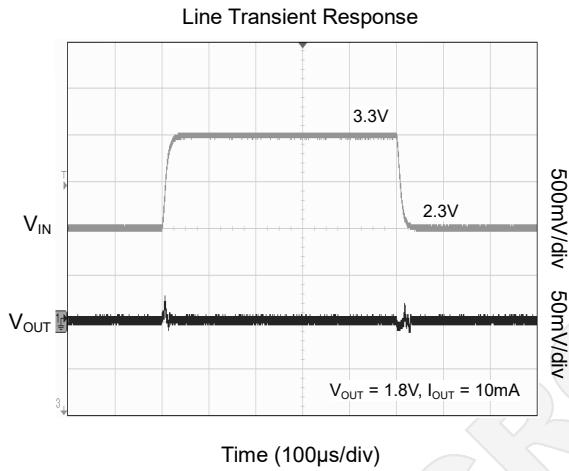
TYPICAL PERFORMANCE CHARACTERISTICS

$T_J = +25^\circ\text{C}$, $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$, $V_{EN} = V_{IN}$, $C_{IN} = C_{OUT} = 1\mu\text{F}$, unless otherwise noted.



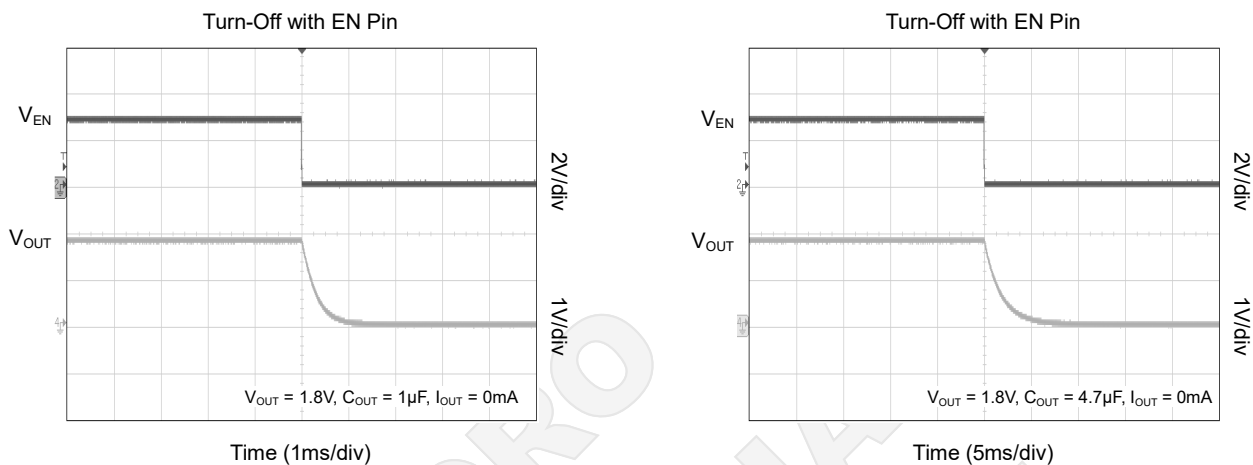
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$T_J = +25^\circ\text{C}$, $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$, $V_{EN} = V_{IN}$, $C_{IN} = C_{OUT} = 1\mu\text{F}$, unless otherwise noted.



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$T_J = +25^\circ\text{C}$, $V_{IN} = V_{OUT(NOM)} + 1.0\text{V}$, $V_{EN} = V_{IN}$, $C_{IN} = C_{OUT} = 1\mu\text{F}$, unless otherwise noted.



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FUNCTIONAL BLOCK DIAGRAM

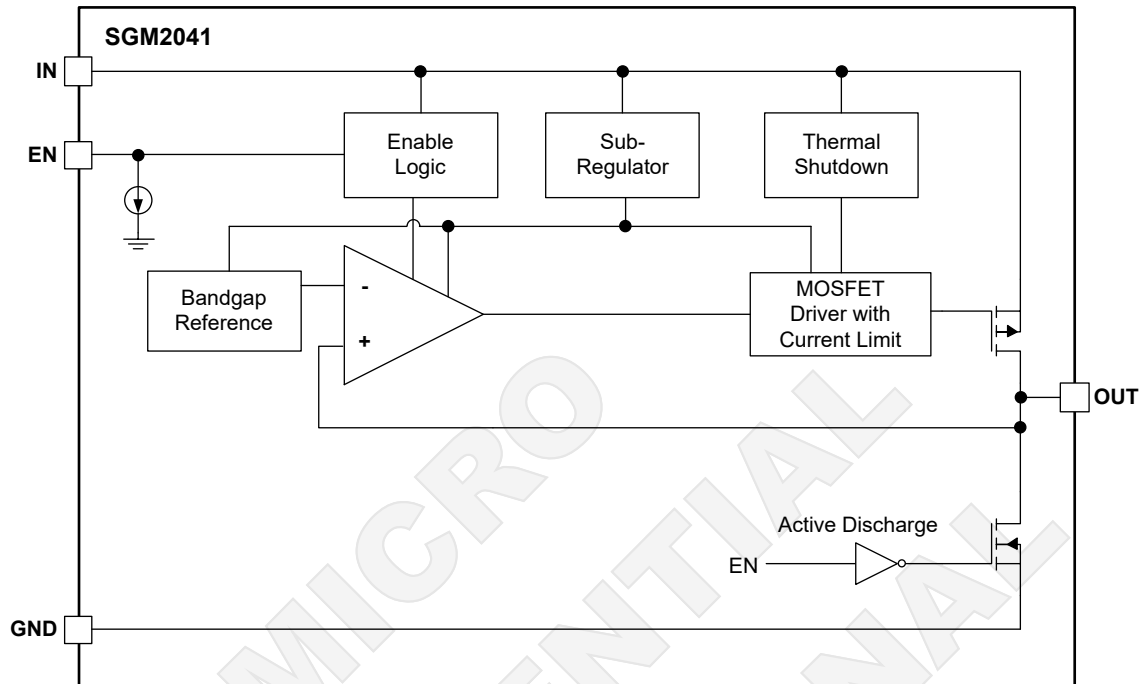


Figure 2. Block Diagram

APPLICATION INFORMATION

The SGM2041 is a 250mA, ultra-low noise and low dropout regulator designed to meet the requirements of RF applications and high performance analog circuits. The SGM2041 device provides very high PSRR and excellent dynamic response. In connection with low quiescent current this device is well suitable for battery powered application such as cell phones, tablets and others. The SGM2041 is fully protected in case of current overload, output short circuit and overheating.

Input Capacitor Selection (C_{IN})

Input capacitor connected as close as possible is necessary for ensuring device stability. The X7R or X5R capacitor should be used for reliable performance over temperature range. The value of the input capacitor should be $1\mu\text{F}$ or greater to ensure the best dynamic performance. This capacitor will provide a low impedance path for unwanted AC signals or noise modulated onto constant input voltage. There is no requirement for the ESR of the input capacitor but it is recommended to use ceramic capacitors for their low ESR and ESL. A good input capacitor will limit the influence of input trace inductance and source resistance during sudden load current changes.

Enable Operation

The SGM2041 uses the EN pin to enable/disable its device and to deactivate/activate the active discharge function.

If the EN pin voltage is $\leq 0.4\text{V}$ the device is guaranteed to be disabled. The pass transistor is turned off so that there is virtually no current flow between the IN and OUT. The active discharge transistor is active so that the output voltage V_{OUT} is pulled to GND through a 220Ω resistor. In the disable state the device consumes as low as typical $0.1\mu\text{A}$ from the V_{IN} .

If the EN pin voltage $\geq 1.5\text{V}$ the device is guaranteed to be enabled. The SGM2041 regulates the output voltage and the active discharge transistor is turned off.

The EN pin has internal pull-down current source with typical value of $0.2\mu\text{A}$ which ensures that the device is turned off when the EN pin is not connected. In the case where the EN function isn't required the EN should be tied directly to IN.

Output Current Limit

Output current is internally limited within the IC to a typical 500mA. The SGM2041 will source this amount of current measured with a voltage drop on the 90% of the nominal V_{OUT} . If the output voltage is directly shorted to ground ($V_{OUT} = 0\text{V}$), the short circuit protection will limit the output current to 220mA (TYP). The current limit and short circuit protection will work properly over whole temperature range and also input voltage range. There is no limitation for the short circuit duration.

Power Dissipation

As power dissipated in the SGM2041 increases, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material and the ambient temperature affect the rate of junction temperature rise for the part.

Reverse Current

The PMOS pass transistor has an inherent body diode which will be forward biased in the case that $V_{OUT} > V_{IN}$. Due to this fact, in cases where the extended reverse current condition can be anticipated the device may require additional external protection.

Power Supply Rejection Ratio

The SGM2041 features very high power supply rejection ratio. If desired the PSRR at higher frequencies in the range from 100kHz to 10MHz can be tuned by the selection of C_{OUT} capacitor and proper PCB layout.

Turn-On Time

The turn-on time is defined as the time period from EN assertion to the point in which V_{OUT} will reach 90% of its nominal value.

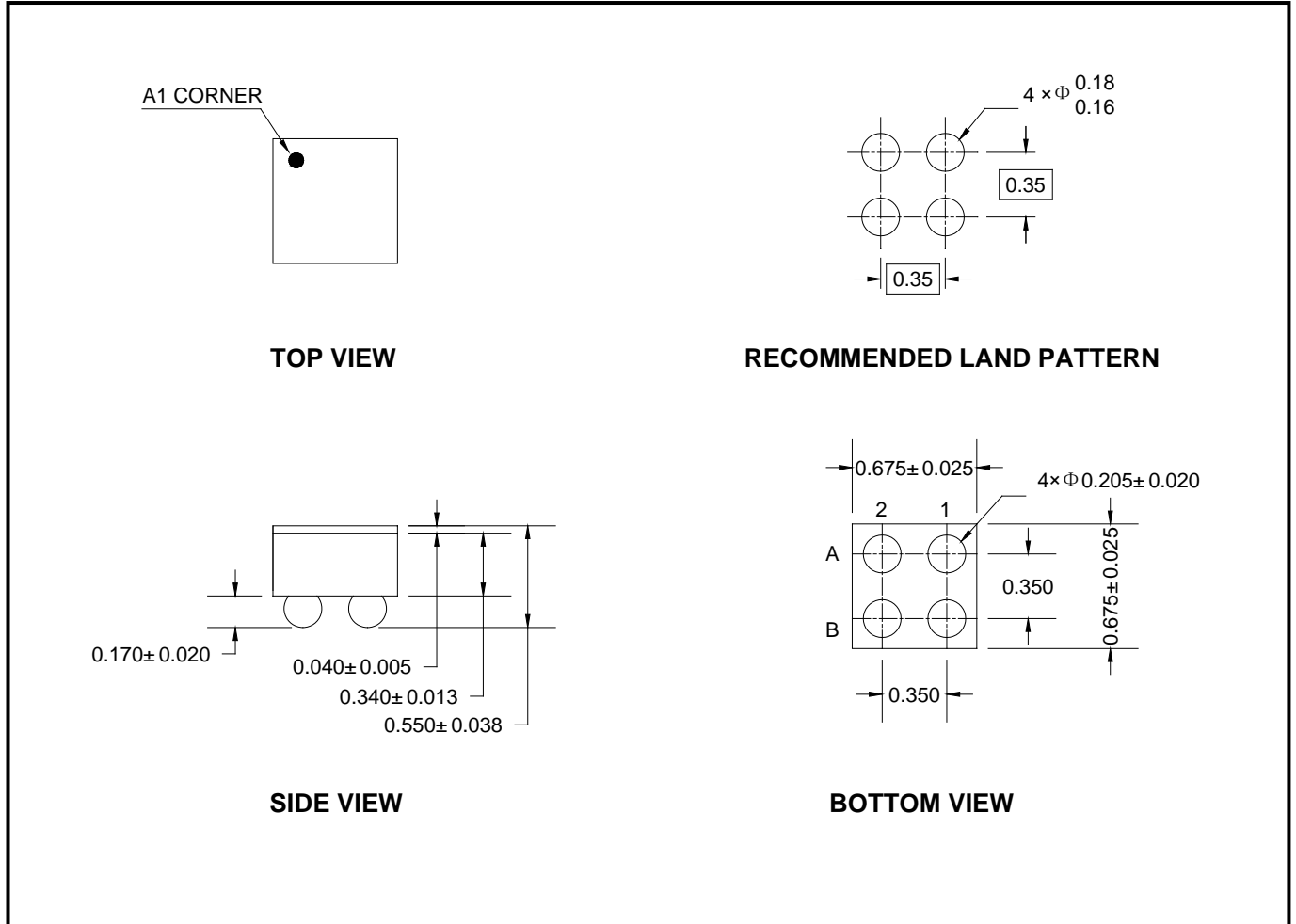
PCB Layout Recommendations

To obtain good transient performance and good regulation characteristics, place input and output capacitors close to the device pins and make the PCB traces wide. In order to minimize the solution size, use 0402 or 0201 capacitors with appropriate capacity. Larger copper area connected to the pins will also improve the device thermal resistance. Exposed pad can be tied to the GND pin for improved power dissipation and lower device temperature.

PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

WLCSP-0.67x0.67-4B



NOTE: All linear dimensions are in millimeters.

PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
WLCSP-0.67×0.67-4B	7"	9.5	0.76	0.76	0.65	4.0	4.0	2.0	8.0	Q1

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

DD0002